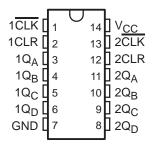
- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 10 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} Supports Partial-Power-Down-Mode Operation
- Dual 4-Bit Binary Counters With Individual Clocks
- Direct Clear for Each 4-Bit Counter
- Can Significantly Improve System
 Densities by Reducing Counter Package
 Count by 50 Percent
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

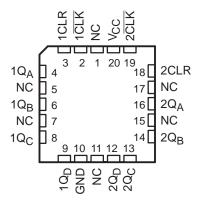
description/ordering information

The 'LV393A devices contain eight flip-flops and additional gating to implement two individual 4-bit counters in a single package. These devices are designed for 2-V to 5.5-V V_{CC} operation.

SN54LV393A . . . J OR W PACKAGE SN74LV393A . . . D, DB, DGV, NS, OR PW PACKAGE (TOP VIEW)



SN54LV393A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

| TA | PACK | AGET | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|--------------|--------------------------|---------------------|
| | colo p | Tube of 50 | SN74LV393AD | 11/2024 |
| | SOIC - D | Reel of 2500 | SN74LV393ADR | LV393A |
| | SOP - NS | Reel of 2000 | SN74LV393ANSR | 74LV393A |
| 4000 +- 0500 | SSOP - DB | Reel of 2000 | SN74LV393ADBR | LV393A |
| -40°C to 85°C | | Tube of 90 | SN74LV393APW | |
| | TSSOP - PW | Reel of 2000 | SN74LV393APWR | LV393A |
| | | Reel of 250 | SN74LV393APWT | |
| | TVSOP - DGV | Reel of 2000 | SN74LV393ADGVR | LV393A |
| | CDIP – J | Tube of 25 | SNJ54LV393AJ | SNJ54LV393AJ |
| –55°C to 125°C | CFP – W | Tube of 150 | SNJ54LV393AW | SNJ54LV393AW |
| | LCCC – FK | Tube of 55 | SNJ54LV393AFK | SNJ54LV393AFK |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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description/ordering informaton (continued)

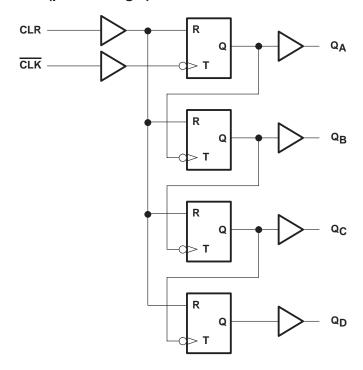
These devices comprise two independent 4-bit binary counters, each having a clear (CLR) and a clock (\overline{\text{CLK}}) input. These devices change state on the negative-going transition of the \overline{\text{CLK}} pulse. N-bit binary counters can be implemented with each package, providing the capability of divide by 256. The 'LV393A devices have parallel outputs from each counter stage so that any submultiple of the input count frequency is available for system timing signals.

These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

FUNCTION TABLE

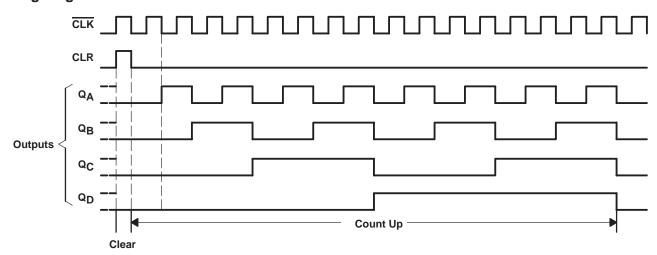
| INP | UTS | FUNCTION |
|--------------|-----|-----------------------|
| CLK | CLR | FUNCTION |
| 1 | L | No change |
| \downarrow | L | Advance to next stage |
| X | Н | All outputs L |

logic diagram, each counter (positive logic)





timing diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | | –0.5 V to 7 V |
|--|--|--|
| Input voltage range, V _I (see Note 1) | | |
| Output voltage range applied in high or low sta | te, V _O (see Notes 1 and 2) | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Output voltage range applied in power-off state | e, VO (see Note 1) | –0.5 V to 7 V |
| Input clamp current, I_{IK} ($V_I < 0$) | | –20 mA |
| Output clamp current, I _{OK} (V _O < 0) | | –50 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | | ±25 mA |
| Continuous current through V _{CC} or GND | | ±50 mA |
| Package thermal impedance, θ _{JA} (see Note 3) | : D package | 86°C/W |
| | DB package | 96°C/W |
| | DGV package | 127°C/W |
| | NS package | 76°C/W |
| | PW package | 113°C/W |
| Storage temperature range, T _{sta} | | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 7 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions (see Note 4)

| | | | SN54I | _V393A | SN74L | V393A | |
|----------|------------------------------------|--|----------------------|----------------------|----------------------|---------------------|------|
| | | | MIN | MAX | MIN | MAX | UNIT |
| Vcc | Supply voltage | | 2 | 5.5 | 2 | 5.5 | V |
| | | V _{CC} = 2 V | 1.5 | | 1.5 | | |
| Maria | High level input value | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | V _{CC} ×0.7 | | V _{CC} ×0.7 | | V |
| VIH | High-level input voltage | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$ | $V_{CC} \times 0.7$ | | $V_{CC} \times 0.7$ | | V |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | $V_{CC} \times 0.7$ | | $V_{CC} \times 0.7$ | | |
| | | V _{CC} = 2 V | | 0.5 | | 0.5 | |
| | Low level input voltage | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | $V_{CC} \times 0.3$ | | $V_{CC} \times 0.3$ | V |
| V_{IL} | Low-level input voltage | V _{CC} = 3 V to 3.6 V | | V _{CC} ×0.3 | | $V_{CC} \times 0.3$ | V |
| | | V _{CC} = 4.5 V to 5.5 V | | V _{CC} ×0.3 | | $V_{CC} \times 0.3$ | |
| ٧ı | Input voltage | | 0 | 5.5 | 0 | 5.5 | V |
| VO | Output voltage | | 0 | [₹] Vcc | 0 | VCC | V |
| | | V _{CC} = 2 V | 3 | -50 | | -50 | μΑ |
| | High lavel autout aumant | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 90 | -2 | | -2 | |
| ЮН | High-level output current | V _{CC} = 3 V to 3.6 V | D. C. | -6 | | -6 | mA |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | -12 | | -12 | |
| | | V _{CC} = 2 V | | 50 | | 50 | μΑ |
| | Law law bandantan and | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2 | | 2 | |
| lOL | Low-level output current | V _{CC} = 3 V to 3.6 V | | 6 | | 6 | mA |
| | | V _{CC} = 4.5 V to 5.5 V | | 12 | | 12 | |
| | | V _{CC} = 2.3 V to 2.7 V | | 200 | | 200 | |
| Δt/Δν | Input transition rise or fall rate | $V_{CC} = 3 V \text{ to } 3.6 V$ | | 100 | | 100 | ns/V |
| | | V _{CC} = 4.5 V to 5.5 V | | 20 | | 20 | |
| TA | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C |

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | TEGT CONDITIONS | 1 ., | SN5 | 4LV393A | | SN74 | LV393A | 1 | |
|------------------|---|--------------|----------------------|---------|------|----------------------|--------|------|------|
| PARAMETER | TEST CONDITIONS | VCC | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| | I _{OH} = -50 μA | 2 V to 5.5 V | V _{CC} -0.1 | | | V _{CC} -0.1 | | | |
| | $I_{OH} = -2 \text{ mA}$ | 2.3 V | 2 | | | 2 | | | ., |
| VOH | $I_{OH} = -6 \text{ mA}$ | 3 V | 2.48 | | | 2.48 | | | V |
| | I _{OH} = -12 mA | 4.5 V | 3.8 | F | | 3.8 | | | |
| | I _{OL} = 50 μA | 2 V to 5.5 V | | FI | 0.1 | | | 0.1 | |
| | $I_{OL} = 2 \text{ mA}$ | 2.3 V | | Q | 0.4 | | | 0.4 | V |
| V_{OL} | I _{OL} = 6 mA | 3 V | 9 | ý, | 0.44 | | | 0.44 | V |
| | I _{OL} = 12 mA | 4.5 V | 2 | | 0.55 | | | 0.55 | |
| lį | V _I = 5.5 V or GND | 0 to 5.5 V | 8 | | ±1 | | | ±1 | μΑ |
| ICC | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | | | 20 | | | 20 | μΑ |
| l _{off} | V_I or $V_O = 0$ to 5.5 V | 0 | | | 5 | | | 5 | μΑ |
| C _i | V _I = V _{CC} or GND | 3.3 V | | 1.8 | | | 1.8 | | pF |

timing requirements over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

| | | | $T_A = 2$ | 25°C | SN54L | V393A | SN74L\ | /393A | LINIT |
|-----------------|----------------|--------------------------|-----------|------|-------|-------|--------|-------|-------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | Dulan demotion | CLK high or low | 5 | | 5 | JC'N | 5 | | |
| τ _W | Pulse duration | CLR high | 5 | | 5 | JIE. | 5 | | ns |
| t _{su} | Setup time | CLR inactive before CLK↓ | 6 | | 6 | | 6 | · | ns |

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

| | | | $T_A = 2$ | 25°C | SN54L\ | /393A | SN74L\ | /393A | LINUT |
|-----------------|----------------|--------------------------|-----------|------|--------|-------|--------|-------|-------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | Dulan danation | CLK high or low | 5 | | 5 | 10,7 | 5 | | |
| t _W | Pulse duration | CLR high | 5 | | 5 | IIE. | 5 | | ns |
| t _{su} | Setup time | CLR inactive before CLK↓ | 5 | | 5 | | 5 | | ns |

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| | | | T _A = 2 | 25°C | SN54L | V393A | SN74L\ | /393A | |
|-----------------|----------------|--------------------------|--------------------|------|-------|-------|--------|-------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | D | CLK high or low | 5 | | 5 ् | 10'N | 5 | | |
| t _W | Pulse duration | CLR high | 5 | | 5 | JIE. | 5 | | ns |
| t _{su} | Setup time | CLR inactive before CLK↓ | 4 | | 4 | | 4 | | ns |

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

| | FROM | то | LOAD | T, | Δ = 25°C | ; | SN54L | /393A | SN74L\ | /393A | |
|------------------|---------|----------------|------------------------|-----|----------|-------|-------|-------|--------|-------|---------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | C _L = 15 pF | 50* | 90* | | 40* | | 40 | | N 41 1- |
| f _{max} | | | C _L = 50 pF | 30 | 70 | | 25 | | 25 | | MHz |
| | | Q_A | | | 7.1* | 17.7* | 1* | 20.5* | 1 | 20.5 | |
| | CLK | QB | | | 8.5* | 20.3* | 1* | 23.5* | 1 | 23.5 | |
| ^t pd | CLK | QC | C _L = 15 pF | | 10* | 22.5* | 1* | 26* | 1 | 26 | ns |
| | | QD | | | 11.1* | 24.2* | 1* | 28* | 1 | 28 | |
| t _{PHL} | CLR | Qn | | | 6.7* | 14.8* | 150 | 17* | 1 | 17 | |
| | | Q_A | | | 9.3 | 21.3 | 01 | 24.5 | 1 | 24.5 | |
| | CLK | QB | | | 10.9 | 23.9 | Q 1 | 27.5 | 1 | 27.5 | |
| ^t pd | CLK | QC | C _L = 50 pF | | 12.3 | 26.1 | 1 | 30 | 1 | 30 | ns |
| | | QD | | | 13.4 | 27.8 | 1 | 32 | 1 | 32 | |
| ^t PHL | CLR | Q _n | | | 9.1 | 17.4 | 1 | 20 | 1 | 20 | |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



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switching characteristics over recommended operation free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

| | FROM | то | LOAD | T, | Վ = 25° C | ; | SN54L | V393A | SN74L | /393A | |
|------------------|---------|----------------|------------------------|-----|------------------|-------|----------------|-------|-------|-------|-------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| £ | | | C _L = 15 pF | 75* | 130* | | 65* | | 65 | | MHz |
| f _{max} | | | $C_L = 50 pF$ | 45 | 105 | | 35 | | 35 | | IVITZ |
| | | Q_A | | | 5.1* | 13.2* | 1* | 15.5* | 1 | 15.5 | |
| | | QB | | | 6* | 15.8* | 1* | 18.5* | 1 | 18.5 | |
| t _{pd} | CLK | QC | C _L = 15 pF | | 7* | 18* | 1* | 21* | 1 | 21 | ns |
| | | Q_{D} | | | 7.7* | 19.7* | 1* | 23* | 1 | 23 | |
| ^t PHL | CLR | Qn | | | 5.1* | 12.3* | 2) | 14.5* | 1 | 14.5 | |
| | | Q _A | | | 6.7 | 16.7 | 2 ₀ | 19 | 1 | 19 | |
| | CLK | QB | | | 7.8 | 19.3 | Q 1 | 22 | 1 | 22 | |
| ^t pd | CLK | QC | C _L = 50 pF | | 8.7 | 21.5 | 1 | 24.5 | 1 | 24.5 | ns |
| | | QD | | | 9.5 | 23.2 | 1 | 26.5 | 1 | 26.5 | |
| ^t PHL | CLR | Qn | | | 6.8 | 15.8 | 1 | 18 | 1 | 18 | |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| 00 | • | | , , | • | • | | | | | | |
|------------------|-------------|----------------|------------------------|------|----------|-------|--------|-------|-------|-------|---------|
| DADAMETED | FROM | то | LOAD | T, | 4 = 25°C | ; | SN54L\ | /393A | SN74L | /393A | |
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | C _L = 15 pF | 125* | 185* | | 105* | | 105 | | N 41 1- |
| f _{max} | | | C _L = 50 pF | 85 | 150 | | 75 | | 75 | | MHz |
| | | Q _A | | | 3.7* | 8.5* | 1* | 10* | 1 | 10 | |
| | | QB | | | 4.3* | 9.8* | 1* | 11.5* | 1 | 11.5 | |
| ^t pd | CLK | QC | C _L = 15 pF | | 4.9* | 11.2* | 1* | 13* | 1 | 13 | ns |
| | | QD | | | 5.3* | 12.5* | 1* 4 | 14.5* | 1 | 14.5 | |
| t _{PHL} | CLR | Qn | | | 3.9* | 8.1* | 150 | 9.5* | 1 | 9.5 | |
| | | Q _A | | | 4.9 | 10.5 | 01 | 12 | 1 | 12 | |
| | | QB | | | 5.6 | 11.8 | Q 1 | 13.5 | 1 | 13.5 | |
| ^t pd | CLK | QC | C _L = 50 pF | | 6.2 | 13.2 | 1 | 15 | 1 | 15 | ns |
| | | Q_{D} | | | 6.6 | 14.5 | 1 | 16.5 | 1 | 16.5 | |
| t _{PHL} | CLR | Qn | | | 5.2 | 10.1 | 1 | 11.5 | 1 | 11.5 | |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



noise characteristics, V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C (see Note 5)

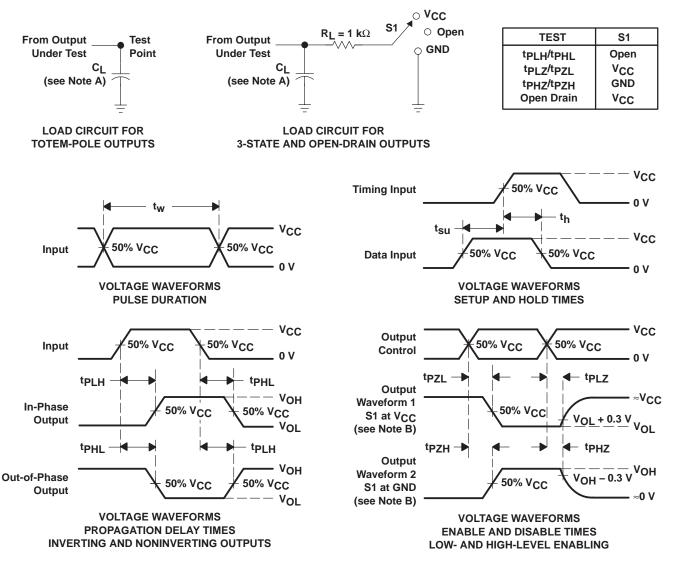
| | DADAMETED | SN | 74LV393 | A | LINUT |
|--------------------|---|------|---------|------|-------|
| | PARAMETER | MIN | TYP | MAX | UNIT |
| VOL(P) | Quiet output, maximum dynamic VOL | | 0.3 | 8.0 | V |
| V _{OL(V)} | Quiet output, minimum dynamic V _{OL} | | -0.2 | -0.8 | V |
| VOH(V) | Quiet output, minimum dynamic VOH | | 2.8 | | V |
| V _{IH(D)} | High-level dynamic input voltage | 2.31 | | | V |
| V _{IL(D)} | Low-level dynamic input voltage | | | 0.99 | V |

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^{\circ}C$

| PARAMETER | | | TEST CONDITIONS | | | UNIT |
|-----------|-------------------------------|-----------------|-----------------|-------|------|------|
| | Power dissipation capacitance | C. 50 pF | f 40 MH I- | 3.3 V | 15.2 | pF |
| Cpd | | $C_L = 50 pF$, | f = 10 MHz | 5 V | 17.3 | |

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: $PRR \le 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_f \le 3 \text{ ns}$, $t_f \le 3 \text{ ns}$.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpz and tpzH are the same as ten.
- G. tpHL and tpLH are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms









PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74LV393AD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADB | PREVIEW | SSOP | DB | 14 | 80 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADBR | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADBRE4 | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADBRG4 | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADG4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADGVR | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADGVRE4 | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADGVRG4 | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ADRG4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ANSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ANSRE4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393ANSRG4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APW | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWE4 | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWG4 | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWR | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWRE4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWRG4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWT | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWTE4 | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV393APWTG4 | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |



PACKAGE OPTION ADDENDUM

4-Jun-2007

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|-------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74LV393ADBR | SSOP | DB | 14 | 2000 | 330.0 | 16.4 | 8.2 | 6.6 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LV393ADGVR | TVSOP | DGV | 14 | 2000 | 330.0 | 12.4 | 6.8 | 4.0 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74LV393ADR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LV393ANSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LV393APWR | TSSOP | PW | 14 | 2000 | 330.0 | 12.4 | 7.0 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |





*All dimensions are nominal

| 7 til difficilisions are normilar | | | | | | | |
|-----------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| SN74LV393ADBR | SSOP | DB | 14 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74LV393ADGVR | TVSOP | DGV | 14 | 2000 | 346.0 | 346.0 | 29.0 |
| SN74LV393ADR | SOIC | D | 14 | 2500 | 346.0 | 346.0 | 33.0 |
| SN74LV393ANSR | SO | NS | 14 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74LV393APWR | TSSOP | PW | 14 | 2000 | 346.0 | 346.0 | 29.0 |

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

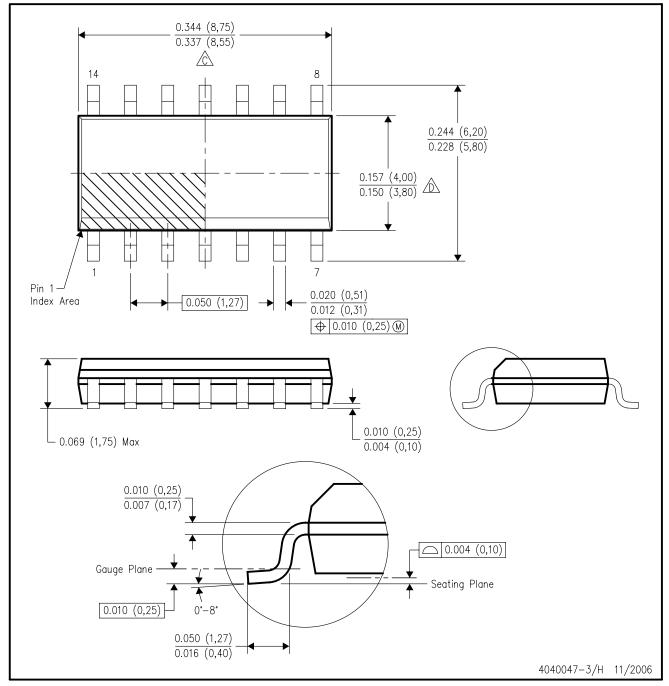
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

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